

S/N 09/382,929

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Paul A. Farrar

Examiner: David Graybill

Serial No.: 09/382,929

Group Art Unit: 2827

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Docket No.: 303.603US1

Title: PACKAGING OF ELECTRONIC CHIPS WITH AIR-BRIDGE STRUCTURES

RESPONSE UNDER 37 C.F.R. § 1.111

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

This paper is filed in response to the Office action mailed on April 16, 2004. Please amend the above-identified patent application as follows.